

Influence of Surface Preparation of Bar-shaped Crystals on Detector's Performance

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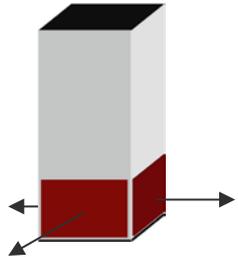
a passion for discovery



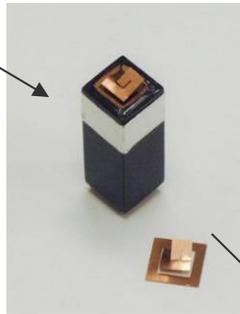
Motivation

Schematic of a position sensitive virtual Frisch-grid detector

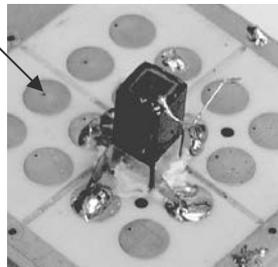
6x6x15 mm³



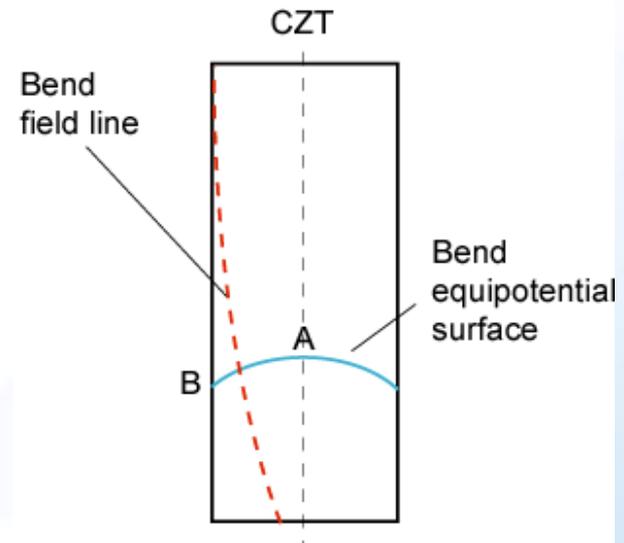
Detector encapsulated inside a thin polyester shell



Assembled detector with two spring-loaded contacts



One important issue left to be solved is to optimize the fabrication process to minimize edge effects to guarantee the correct distribution of potential on the sidewalls of the bar detectors and to ultimately produce a device with focusing E-field

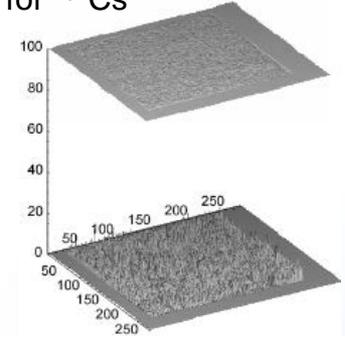
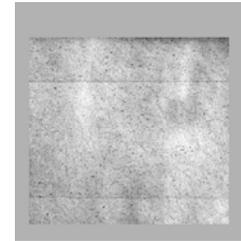
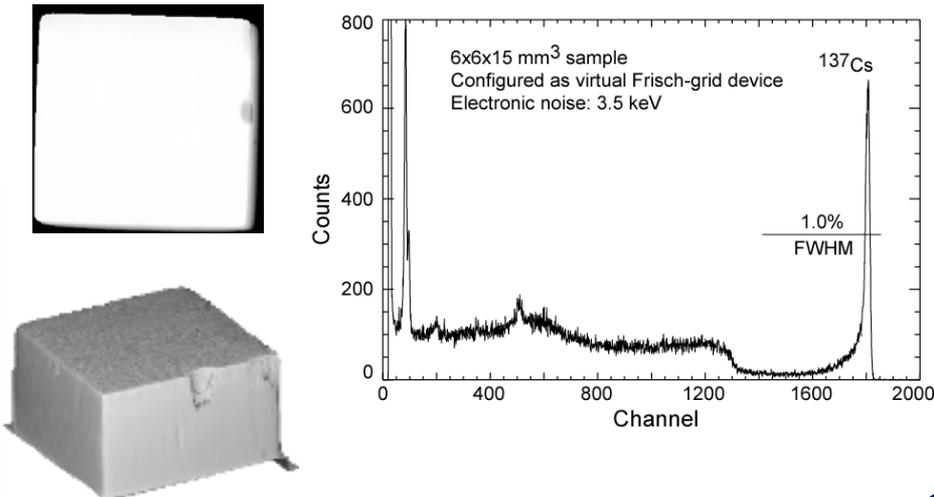


We have demonstrated that position-sensitive detectors can overcome the response nonuniformity in large-volume CdZnTe crystals

An Excellent Bar Detector

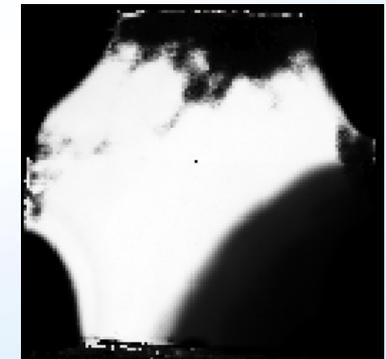
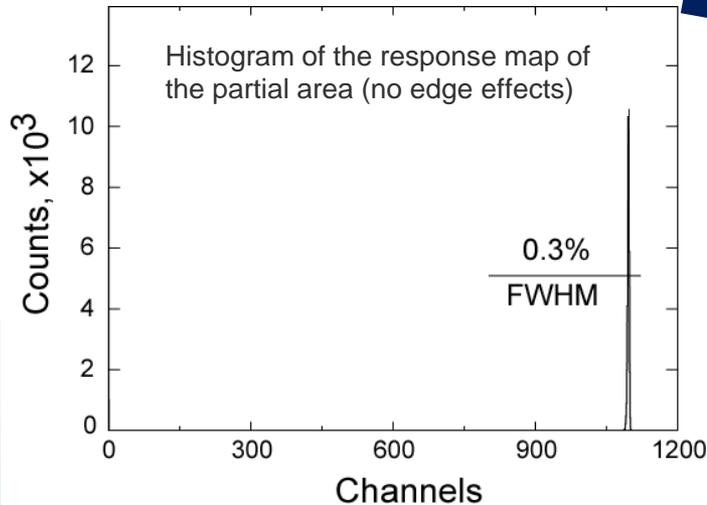
For each bar detector tested we measured

- Histogram of pulse height spectra
- Energy spectra for ^{137}Cs

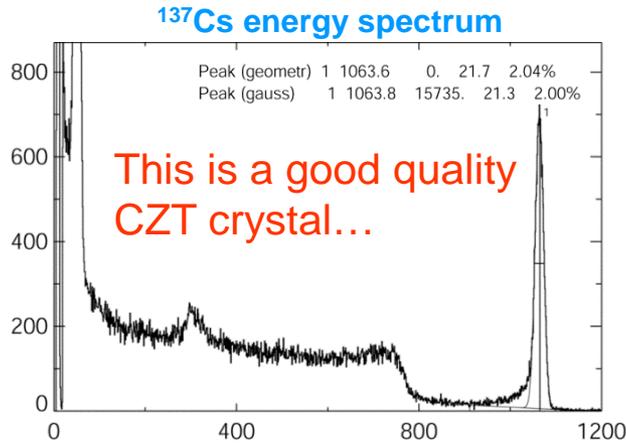


Partial area X-ray response map (no edge effects) 3D plot of partial area X-ray Response map

2D and X-ray response maps

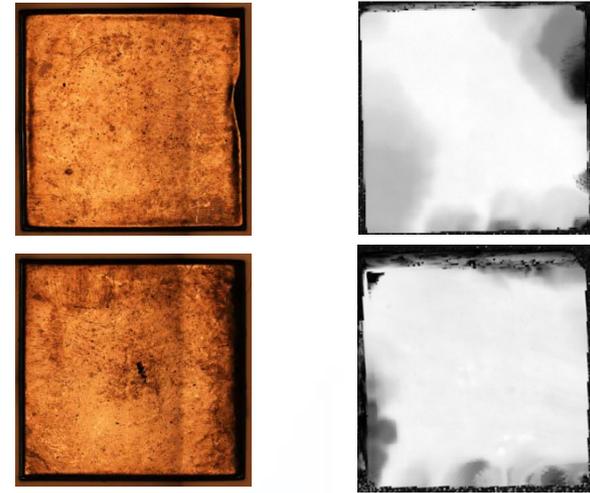


An Average Bar Detector



Micrographs

X-ray response maps



For this detector geometry the surface resistivity plays a very important role in the performance and efficiency of the detector

What is responsible for the incomplete charge collection near certain detector's edges?

A simple answer is that there is weak or defocusing E-field in those regions due to ...

Surface preparation?, Fabrication process?, Crystal orientation?
Surface treatment?



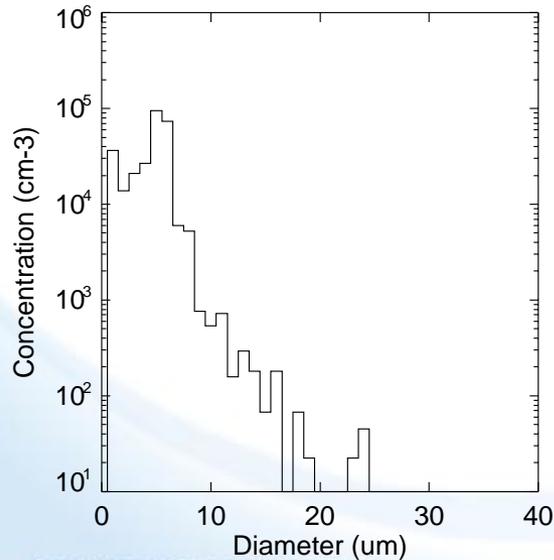
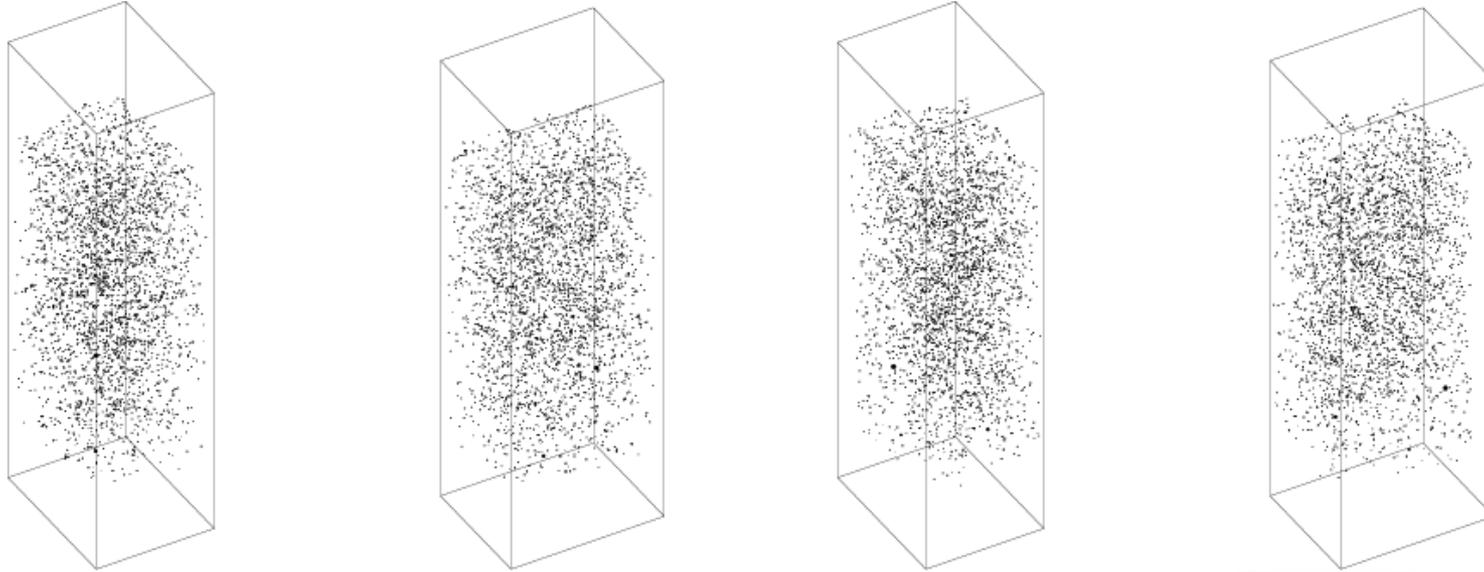
Many detectors received did not perform as expected. We refabricated them, tried different surface treatments and tested them with the micro-beam at Beamline X27B

Cathode

6 x 6 x 15 mm³ CZT

IR Transmission: Extended Defects Distribution

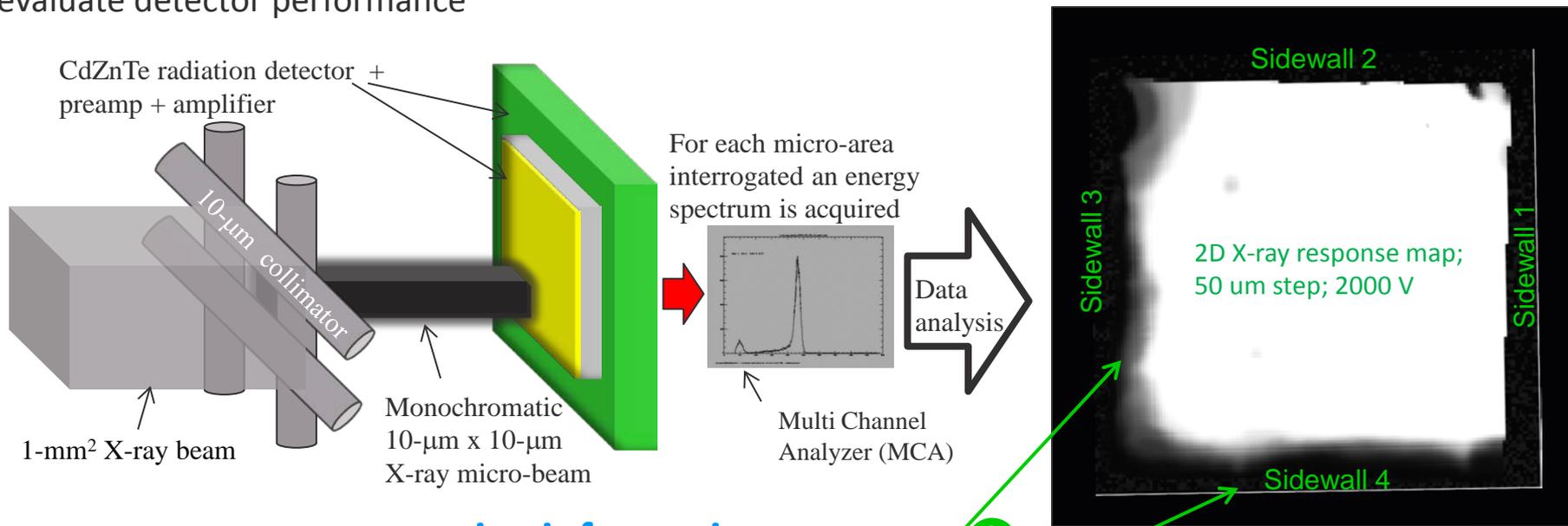
Volumetric regions size: $1.1 \times 1.5 \times 5 \text{ mm}^3$



These images and distribution of extended defects are representative of all the bar detectors that were measured

Characterization Technique: X-ray Response Maps

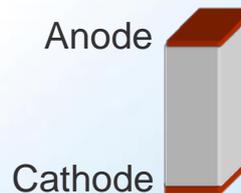
Micro-scale X-ray Detector Response Mapping is a unique and powerful measurement technique to evaluate detector performance



X-ray response maps can give information on:

1. Detector polarization
2. Local and global E-field non-uniformity
3. Extended defects
4. Electrode- and side-surfaces fabrication damage
5. Electrodes design
6. Nonuniformity of material

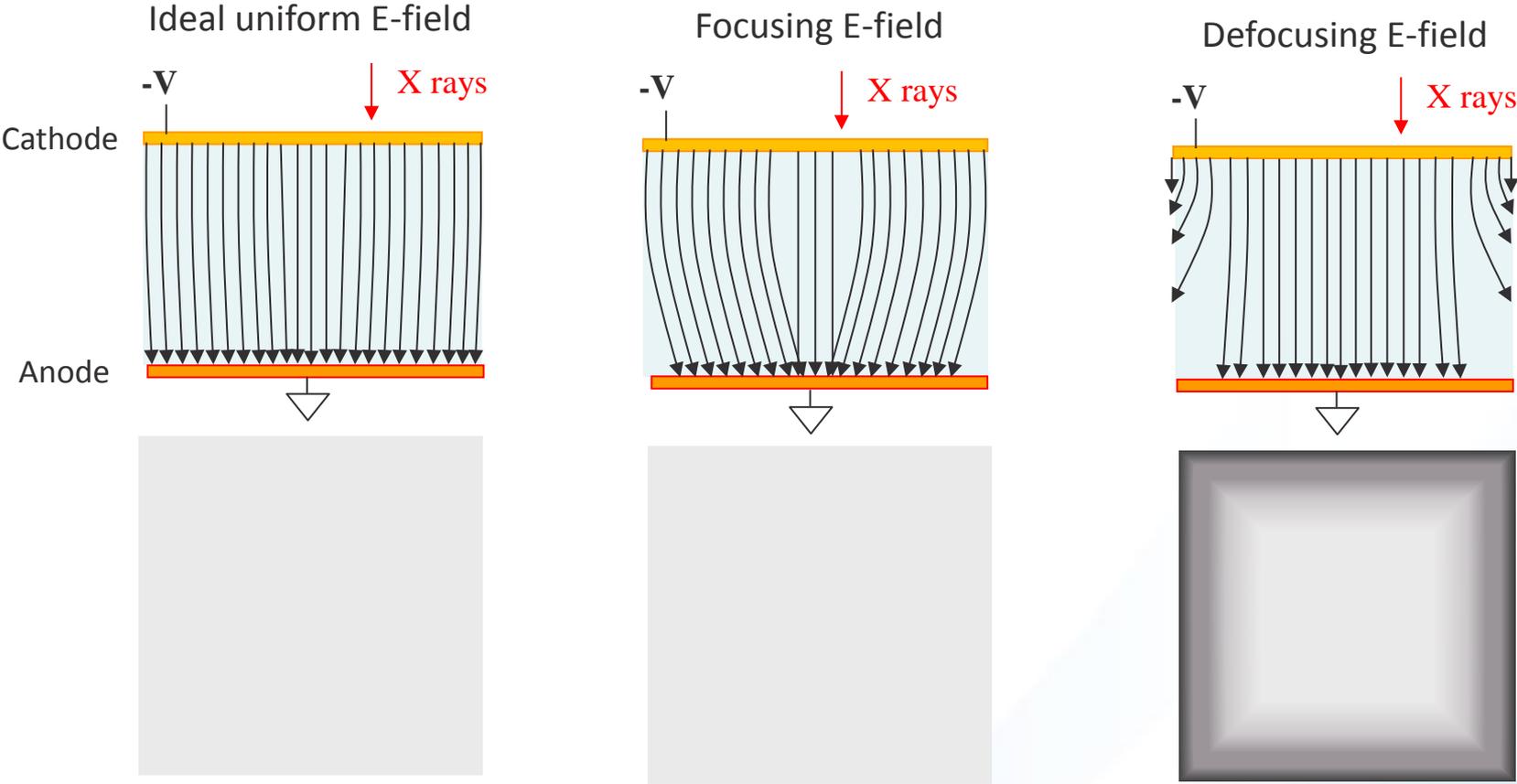
2D X-ray response map of a 6 x 6 x 15 mm³ CZT detector



Why is there incomplete charge collection near the anode's edges 3 and 4?

Responsible for deteriorating energy resolution in spectrometers and for introducing aberrations in imaging devices

Understanding X-ray Response Maps versus E-field

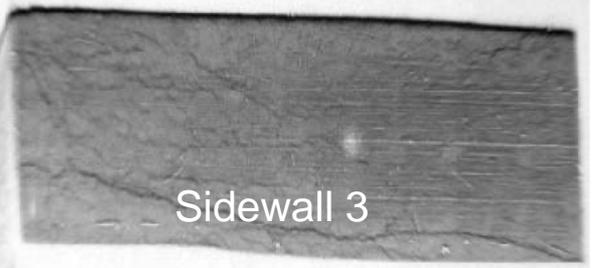


X-ray response maps

If an X-ray-response-map dimension corresponds to the anode area, this implies that the E-field of the device is focusing

WBXDT Images and Bright-Field Micrographs

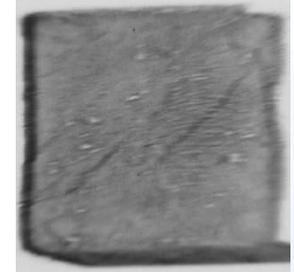
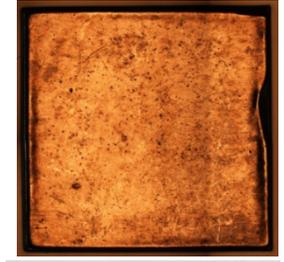
WBXDT images



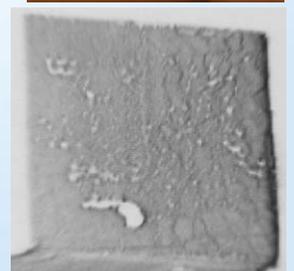
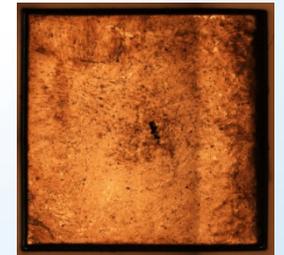
Micrographs



Anode

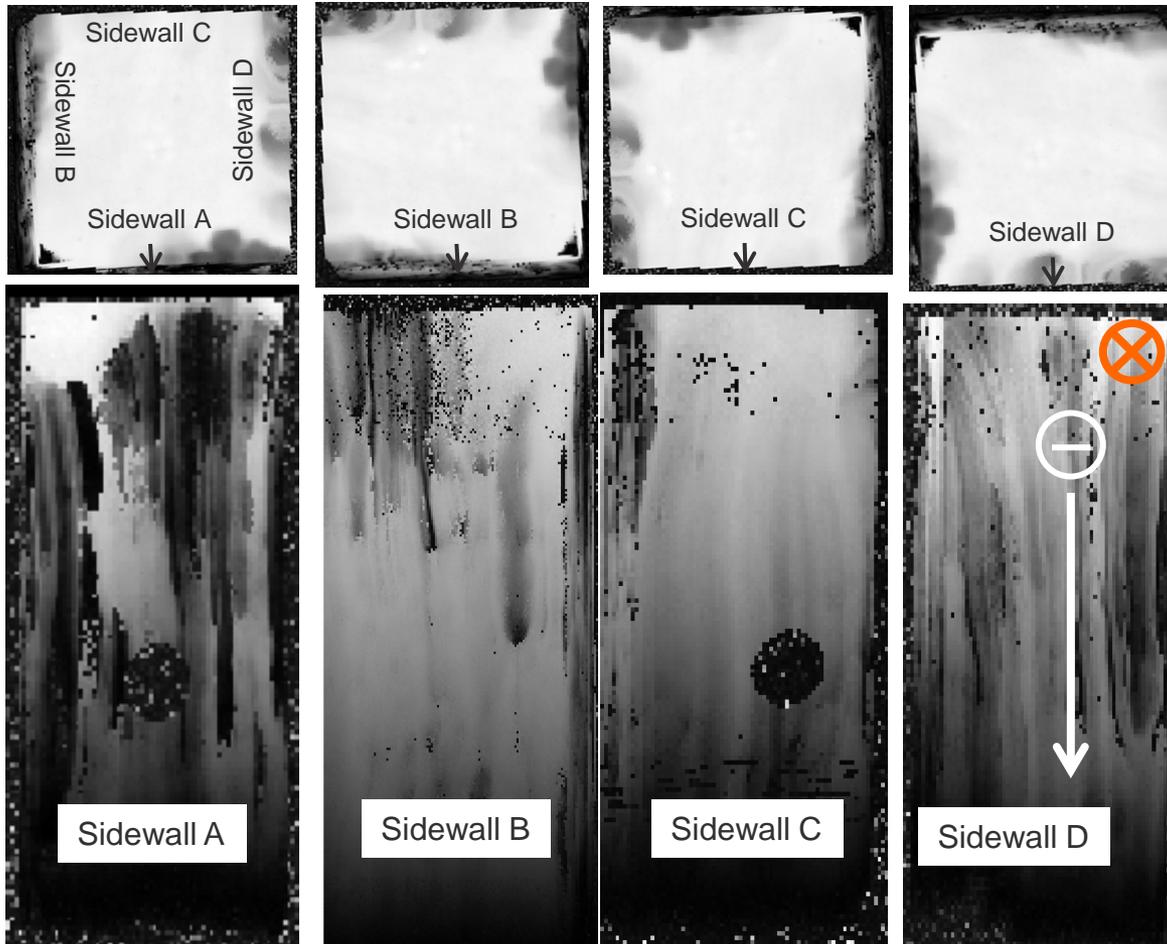


Cathode



Extended defects and surface preparation are revealed

X-ray Response Maps with Anode as Collecting Electrode



X-ray-maps' step-size of the sidewalls is 100 μm

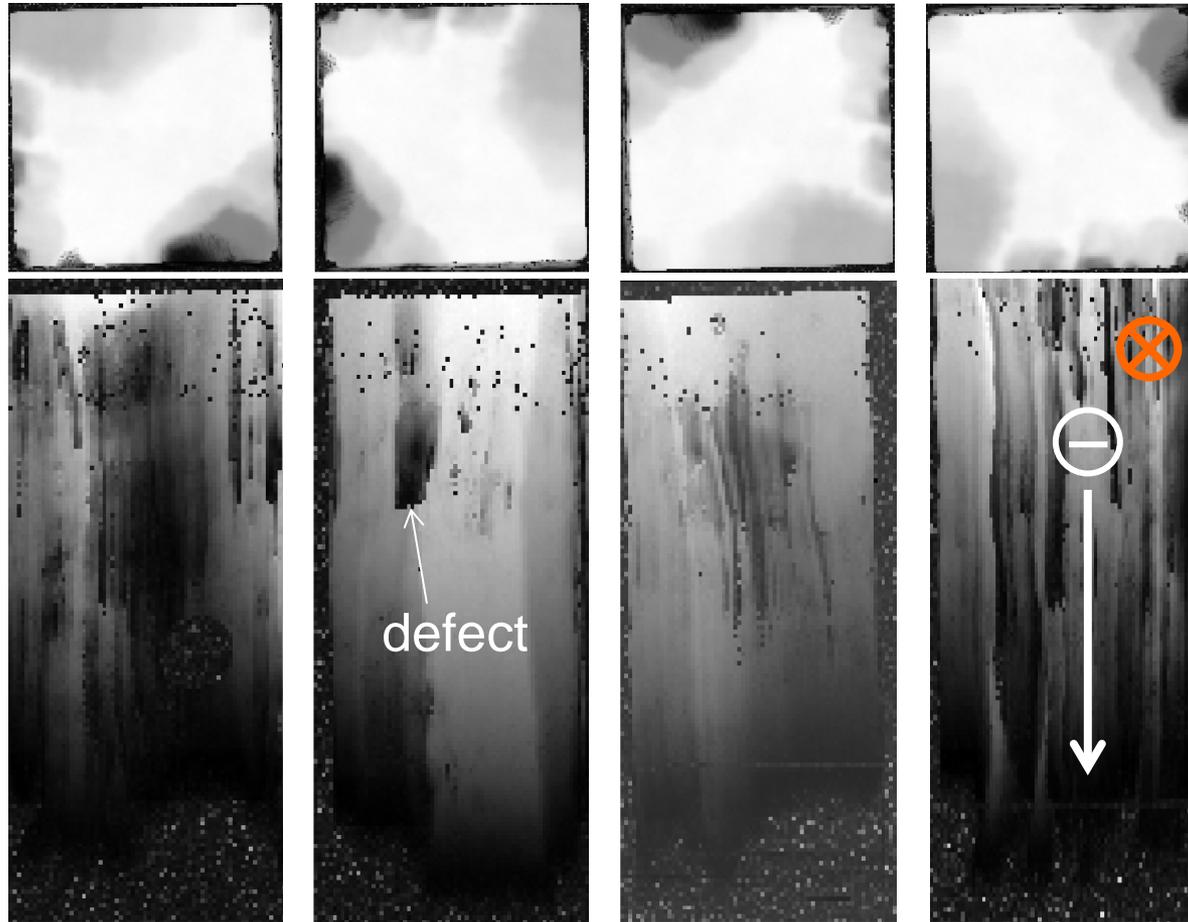
X-rays

These non-uniformities in the X-ray response maps are indicative of defocusing local E-field due to both extended defects and surface preparation

← Collecting-electrode side

Overall there is focusing global E-field in this detector
Defects affect the local E-field

X-ray Response Maps with Cathode as Collecting Electrode



The step size of the raster scan of the sidewalls is 100 μm

X-rays

These X-ray response maps are the result of both drift and diffusion of the electron's cloud generated by the X-ray micro-beam

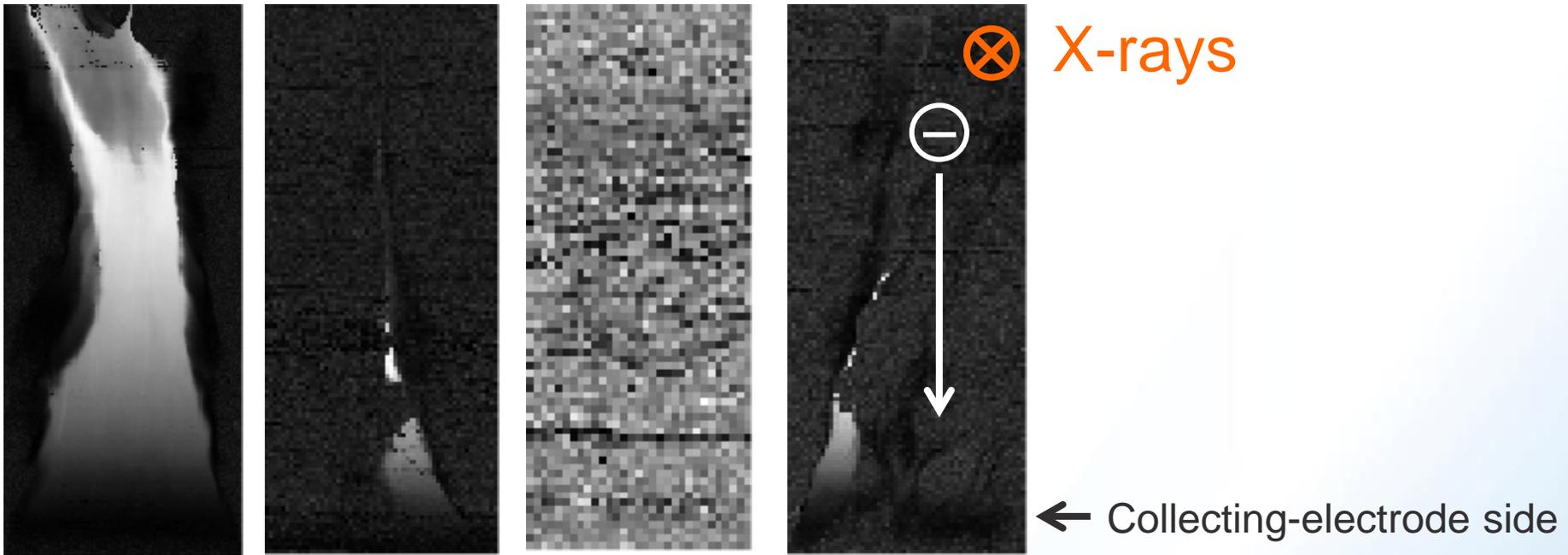
← Collecting-electrode side

Defocusing E-field is responsible for the dark regions

These regions are often not visible with an optical microscope (internal crystal damage?); therefore, optical microscopy is not suitable to evaluate the optimal surface preparation for high charge collection along the edges

Detector Mechanically Polished with 1200-grit SiC Paper

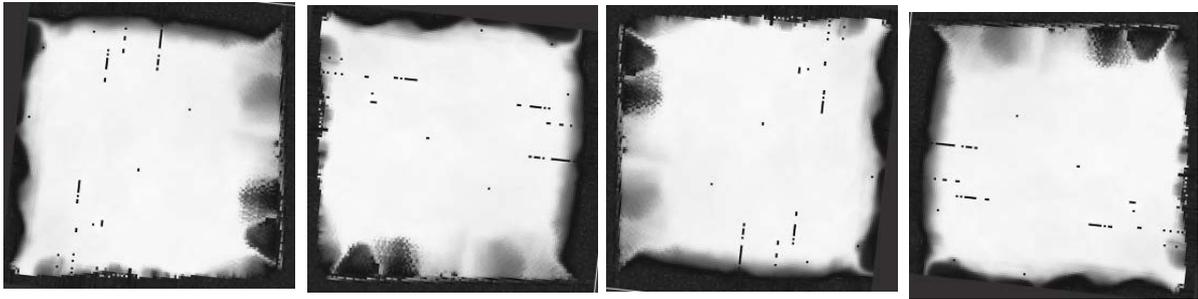
X-ray-maps' step-size of the sidewalls is 100 μm



These non-uniformities in the X-ray response maps are indicative of defocusing local E-field due to both extended defects and surface preparation

Also polarization is observed in the dark-grey regions

Detector Mechanically Polished with 3 μm AlO_2 Powder on Velvet Cloth



X-ray-maps' step-size of the sidewalls is 100 μm



X-rays

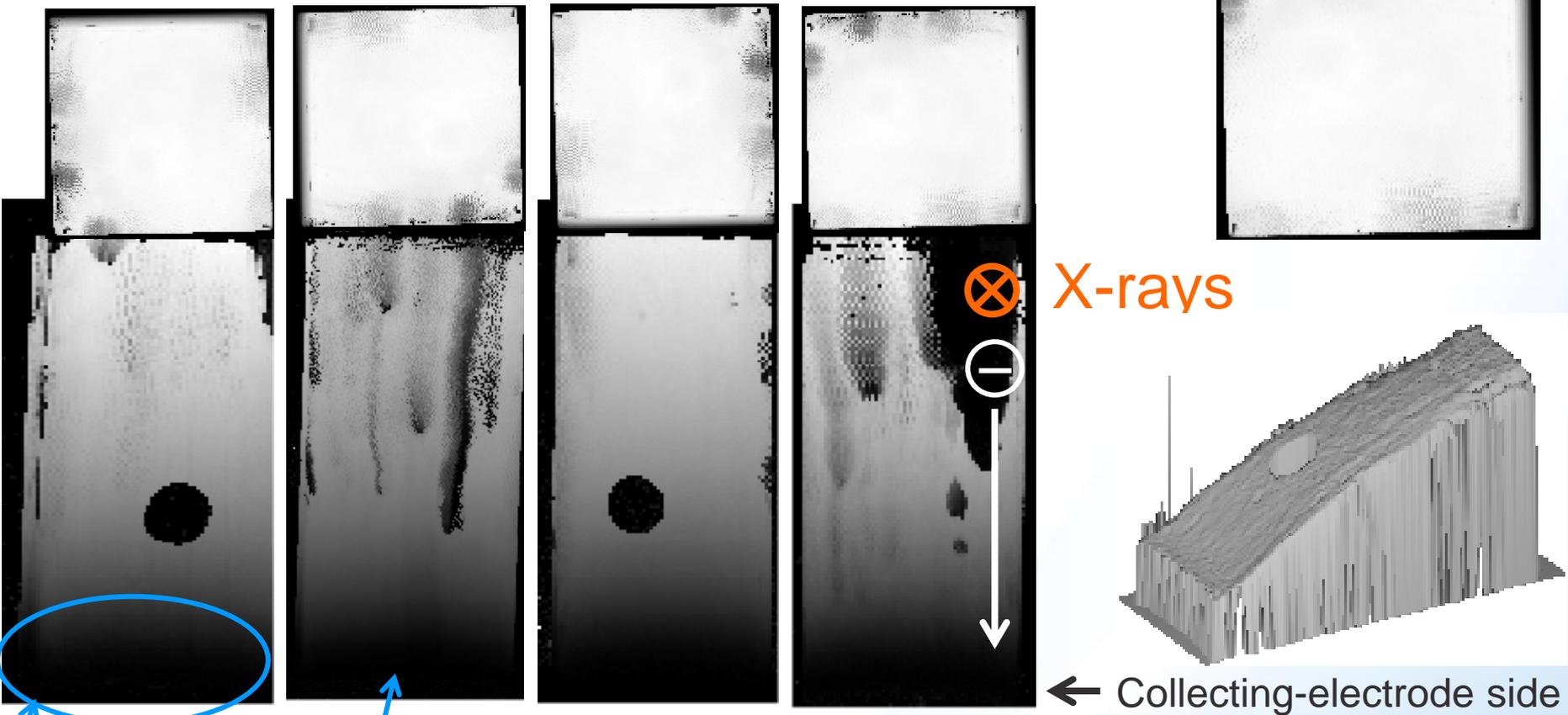
Preparation and orientation (surface conductivity) of the side-surfaces seems to affect the performance of the detector

← Collecting-electrode side

Sidewalls 1 and 2: these non-uniformities in the X-ray response maps are indicative of defocusing local E-field due to both extended defects and surface preparation. Maybe the resistivity of sidewalls 3 and 4 is too high. $R_s = 300 \text{ G}\Omega/\square$

Detector Chemically Etched

X-ray-maps' step-size of the sidewalls is 100 um

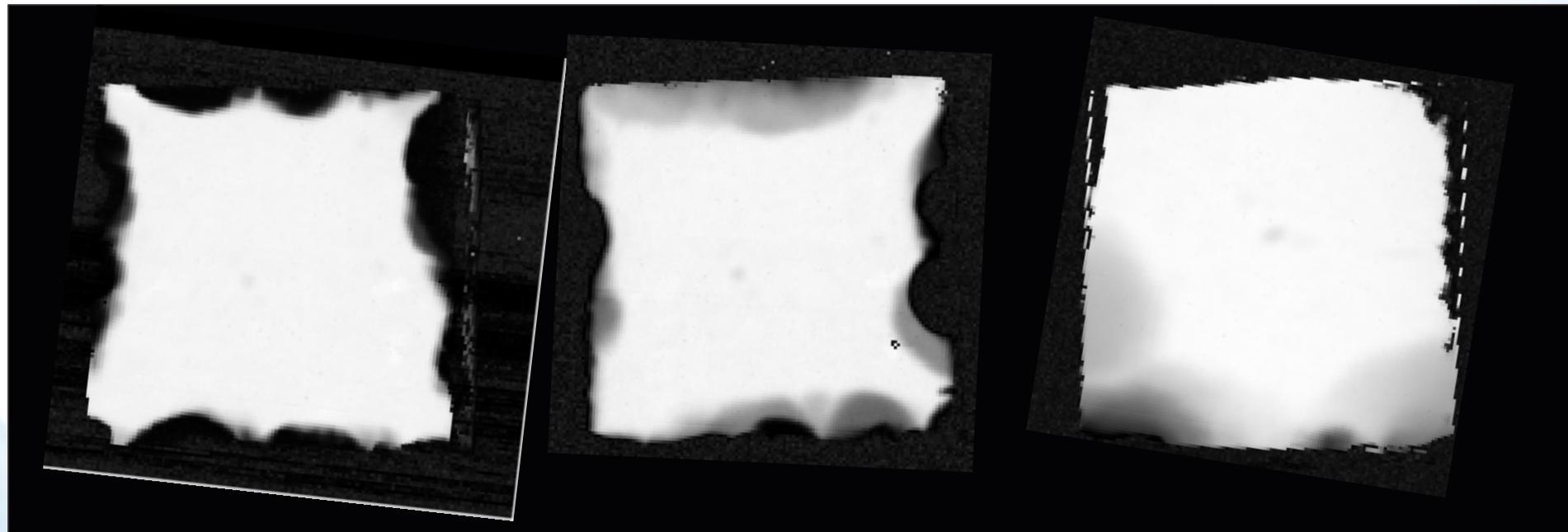


Remember, no signal generated when the pencil beam irradiates the sidewall near the anode
Preparation and orientation (surface conductivity) of the side-surfaces seems to be important to control the surface leakage current (resistivity, charge recombination, and local E-field). $R_s = 80 \text{ G}\Omega/\square$

A CZT Detector from As-received to Refabricated

Detectors that did not meet the requirements were mechanically polished, chemically etched in Bromine-methanol solutions at different concentrations, passivated with different chemical solutions, such as CS_2 and $\text{NH}_4\text{F} + \text{H}_2\text{O}_2$. The best results were obtained when using $<0.5\%$ Bromine etching, which increased the surface leakage current to a certain extent to ultimately assure the correct distribution of potential on the edges for a focusing E-field. The surface resistivity was measured to be: $R_s = 111 \text{ G}\Omega/\square$

X-ray response maps



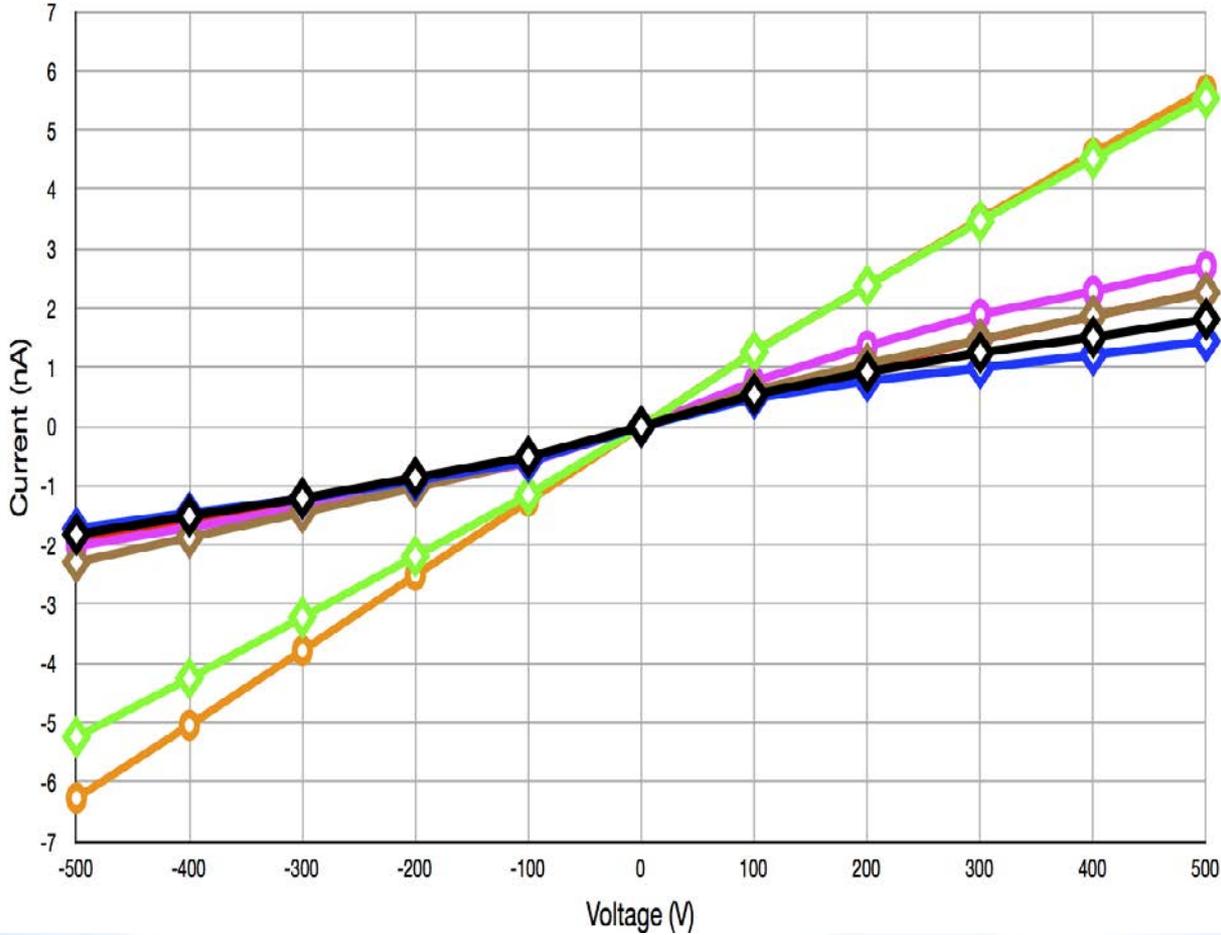
As received

Mechanically polished

Chemically etched

I-V Curves of One of the Bar Detectors

BeV 12-02



IV Curve

- As received
- After CS₂
- After Polishing
- After NH₄F+H₂O₂
- After Br-etching
- After Br-etching (new contact)
- After Br-etching 2nd time
- After Br-etching 2nd time (new contact)

Conclusions

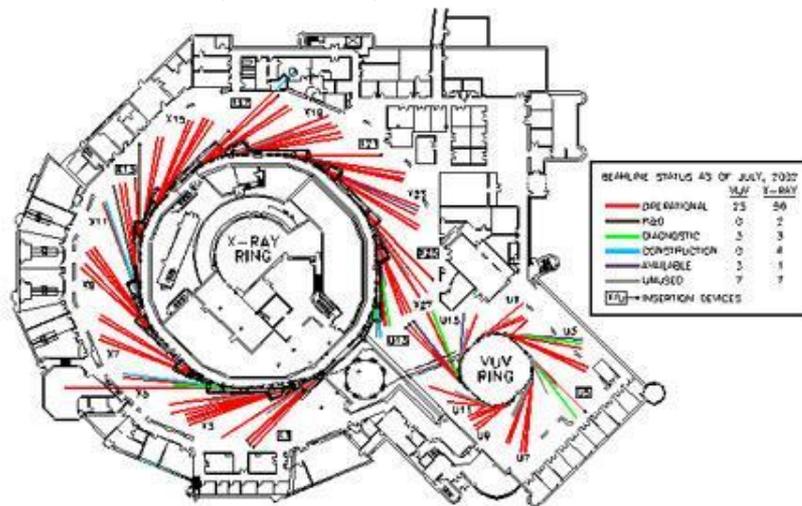
- Extended defects and surface treatment affect the local E-field
- Optical microscopy seems inadequate to reveal relevant crystal damage and therefore to evaluate the optimal surface preparation
- WBXDT gives information on crystal defects
- MXDM gives information on the effects of (1) orientation, (2) surface preparation, (3) global- , and (4) local E-field non-uniformity
- MXDM can be employed to improve the surface preparation of a device
- Bromine-methanol etched samples showed a focusing E-field

Future Work

- More detectors need to be measured
- Continue to measure detectors with different surface preparation
- Install and measure detectors with a multi-channel readout system
- Receive and measure YOUR samples and detectors

Acknowledgments

BNL's National Synchrotron Light Source (NSLS) is a user facility



- NSLS at Brookhaven National Laboratory in New York is a national user research facility founded by the U.S. Department of Energy's Office of Basic Energy Sciences

For more information: <http://www.bnl.gov/ps/> GiuseppeC@bnl.gov

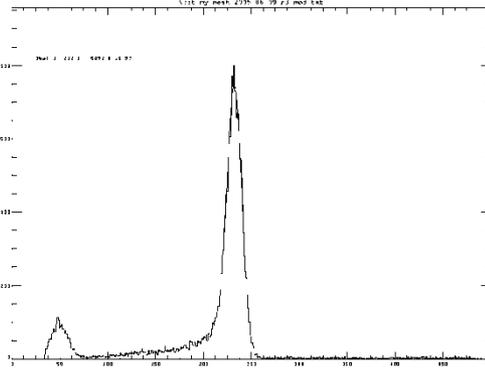
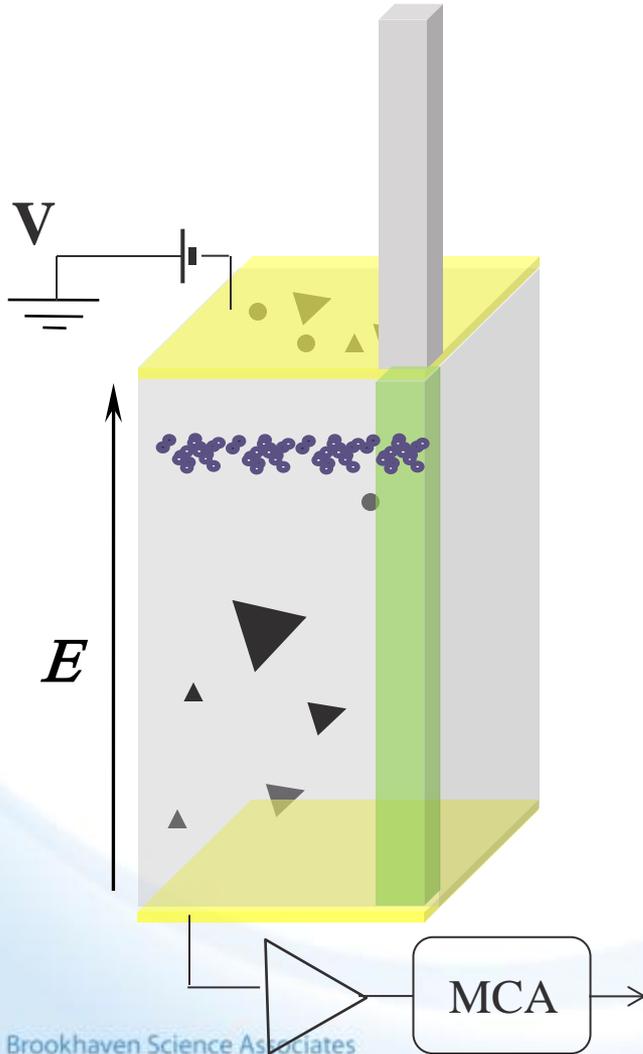
- Please come to visit or send samples if you are interested
- Thanks for the support to the U.S. Department of Energy, Defense Nuclear Nonproliferation R&D, DNN R&D

Thank you for your attention!

Extra Slides

MXDM - Charge Loss with X27B X-ray Beam

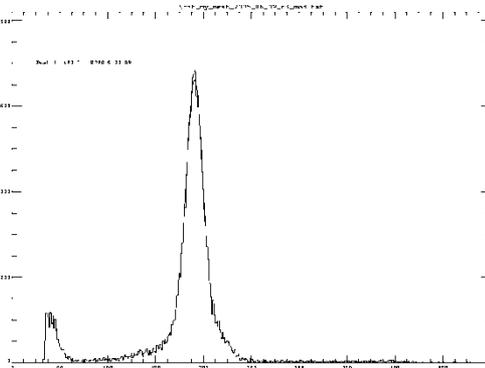
A monochromatic X-ray micro-beam is used to map the whole area of the detector



Full charge collection:

Photopeak at ch 480:

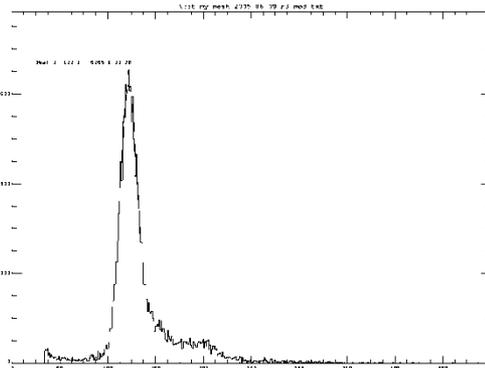
No defect is in the path



Some charge is trapped:

Photopeak at ch 350:

A small defect is in the path



More charge is trapped:

Photopeak at ch 150:

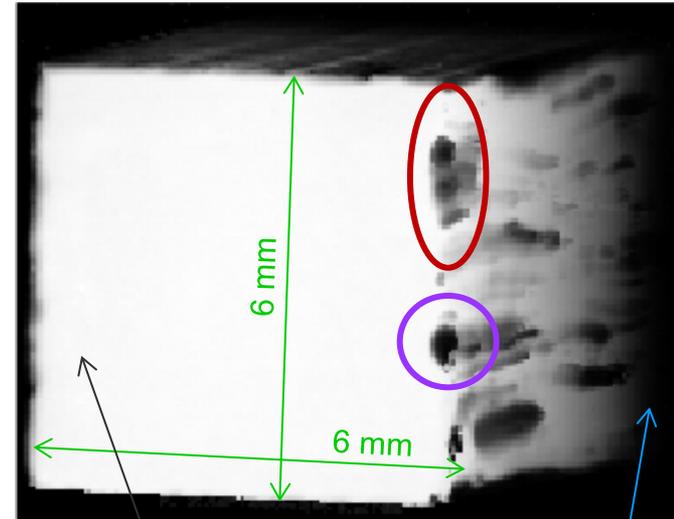
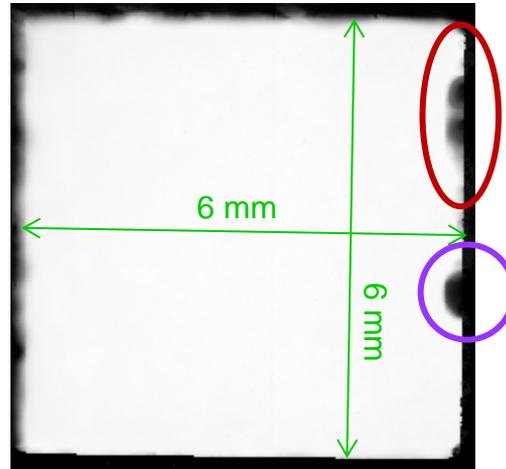
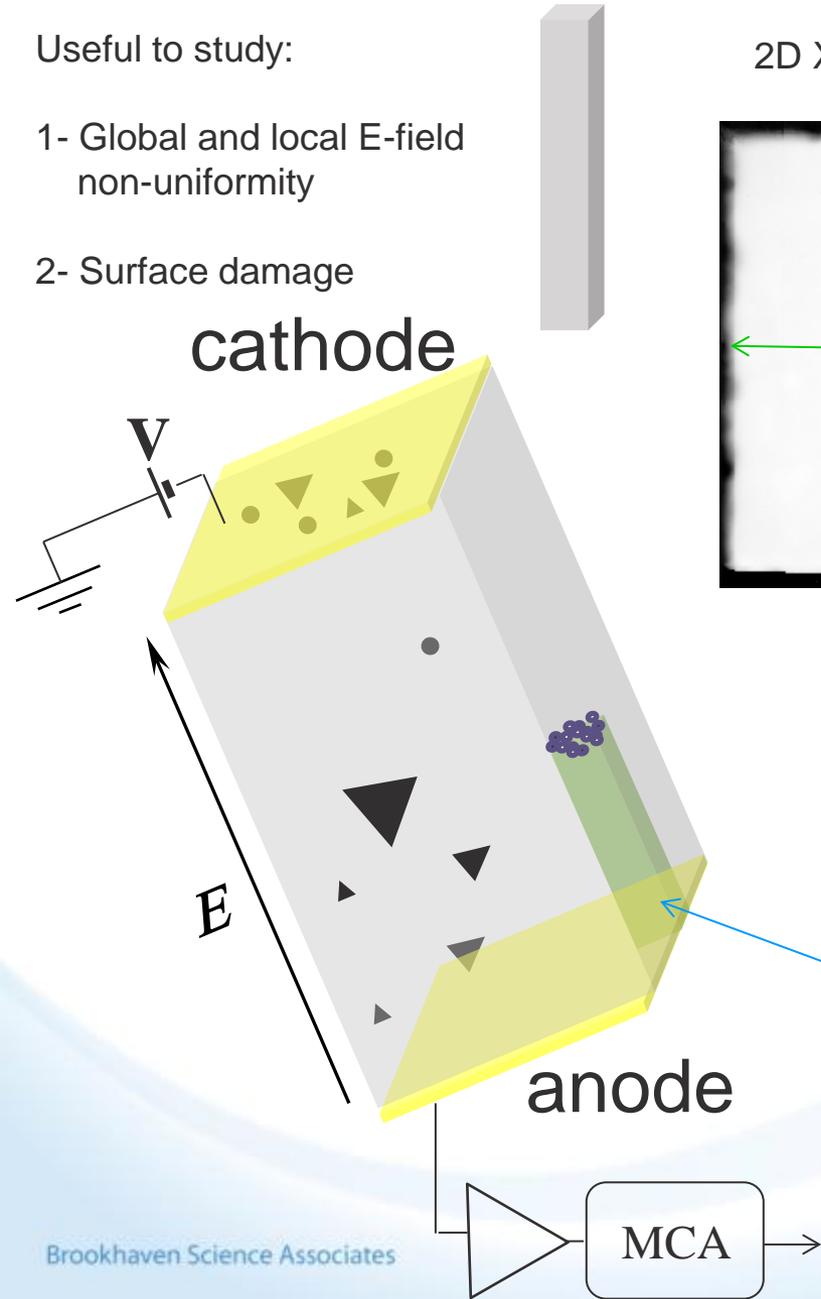
A large defect is in the path

MXDM – Irradiating the Sidewalls

Useful to study:

- 1- Global and local E-field non-uniformity
- 2- Surface damage

2D X-ray response maps of a 6 x 6 x 15 mm³ CZT detector



The global E-field is focusing because the X-ray response map extends to the edges of the anode electrode

No signal generated when the pencil beam irradiates the sidewall near the anode